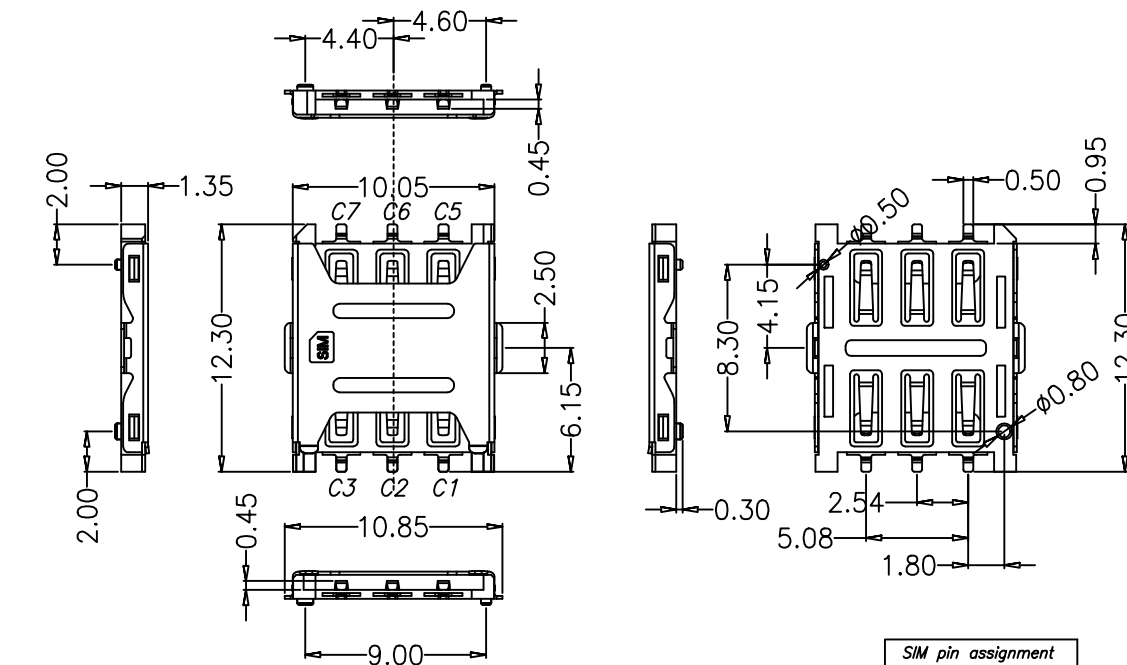
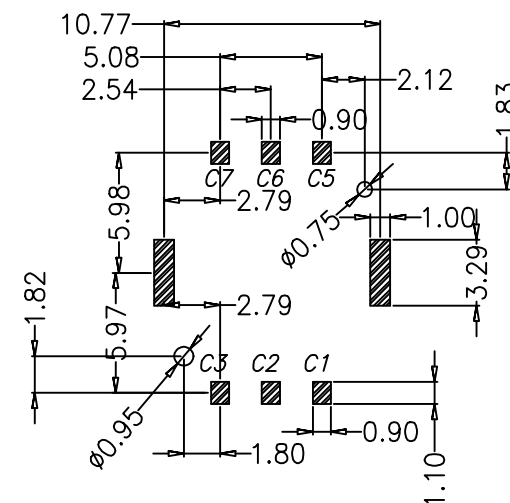


SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出



Specification

MATERIAL:

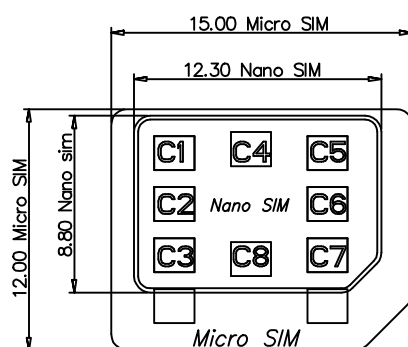
Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: C5210
SHELL: SIS

PLATING:

Contact: Plated 50u'' Ni Overall Contact ALL Au 1U,
 Shell: Plated 50u'' Ni Overall. PAD Au 1U

Electrical:

Current Rating : 0.5A AC/DC max.
Voltage Rating : 125V AC/DC
Ambient Temperature Range : -20° C +60° C
Storage Temperature Range : -40° C +70° C
Ambient Humidity Range : 95% R.H. Max.
Contact Resistance: 100mΩ max.
Insulation Resistance: 1000MΩ min./500VDC
Mating Cycles: 10,000 Insertions
Reflow peak temp. : 260° C ±5° C, 5" S
Mating Cycles: 3,000 Insertions Min



GENERAL TOLERANCE		KINGCONN	皇海科技股份有限公司	
X± 0.50	X* ± 0			
.X± 0.30	.X* ± 0			
.XX± 0.20	.XX* ± 0			
		名 稱(TITLE)	NAND-SIM 卡座 NO PUSH H1.35	
單位(UNIT)		料 號(PART NO.)	圖 號(DWG NO.)	
mm		7SIMC-F0-0030	7SIMC-F0-0030	
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	主 尺 寸 比 例 SCALE 1:1	張 數 SHEET 1 / 1
			繪 圖 符 號 REF.	更 改 REV. A